

# NCP585

## Tri-Mode 300 mA CMOS LDO Regulator with Enable

The NCP585 series of low dropout regulators are designed for portable battery powered applications which require precise output voltage accuracy, low quiescent current, and high ripple rejection. These devices feature an enable function which lowers current consumption significantly and are offered in the SOT23-5 and the HSON-6 packages, in fixed output voltages between 0.8 V and 3.3 V.

This series of devices have three modes. Chip Enable (CE mode), Fast Transient Mode (FT mode), and Low Power Mode (LP mode). Both the FT and LP mode are utilized via the ECO pin.

### Features

- Tri-mode Operation
- Low Dropout Voltage:
  - Typ 550 mV at 300 mA, Output Voltage = 0.9 V
  - Typ 480 mV at 300 mA, Output Voltage = 1.0 V
  - Typ 310 mV at 300 mA, Output Voltage = 1.5 V
- Excellent Line Regulation of 0.01%/V (0.05%/V LP Mode)
- Excellent Load Regulation of 15 mV (40 mV FT Mode)
- High Output Voltage Accuracy of  $\pm 2\%$  ( $\pm 3\%$  LP mode)
- Ultra-Low  $I_Q$  Current of:
  - 3.5  $\mu A$  (LP mode, Output Voltage < 1.6 V)
  - 80  $\mu A$  (FT mode, Output Voltage < 1.8 V)
  - 60  $\mu A$  (FT mode, Output Voltage = 1.8 V)
- Very Low Shutdown Current of 0.1  $\mu A$
- Excellent Power Supply Rejection Ratio of 70 dB at  $f = 1.0$  kHz
- Low Temperature Drift Coefficient on the Output Voltage of  $\pm 100$  ppm/ $^{\circ}C$
- Fold Back Protection Circuit
- Input Voltage up to 6.5 V
- These are Pb-Free Devices

### Typical Applications

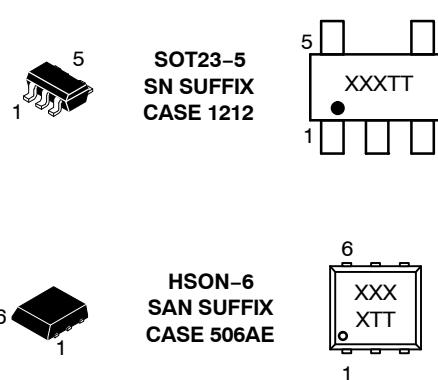
- Portable Equipment
- Hand-Held Instrumentation
- Camcorders and Cameras



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### MARKING DIAGRAMS



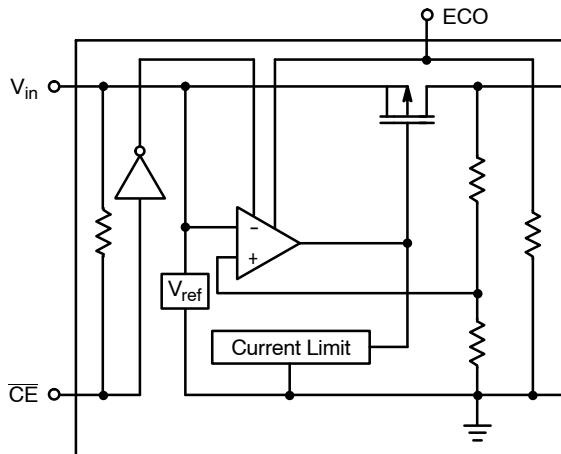
XXX = Specific Device Code  
TT = Traceability Information

### ORDERING INFORMATION

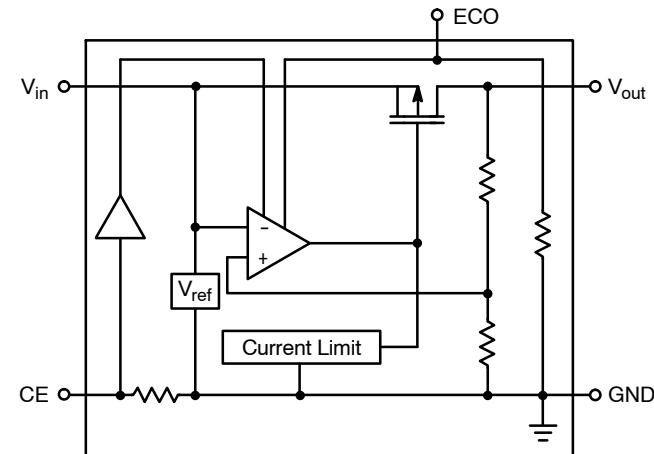
See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.

\*Additional voltage options may be available between 0.8 V and 3.3 V in 100 mV steps.

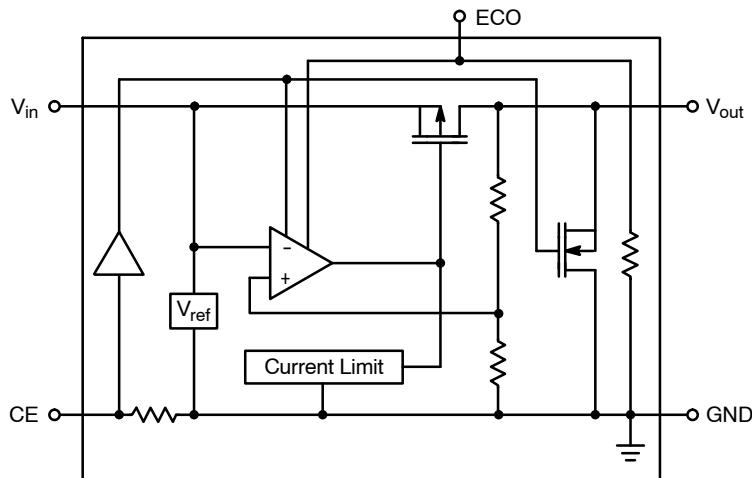
# NCP585



**Figure 1. Simplified Block Diagram for Active Low**



**Figure 2. Simplified Block Diagram for Active High**



**Figure 3. Simplified Block Diagram for Active High with Auto Discharge**

## PIN FUNCTION DESCRIPTION

HSON-6	SOT23-5	Pin Name	Description
1	1	$V_{in}$	Power supply input voltage.
2	-	NC	No Connect.
3	5	$V_{out}$	Regulated output voltage.
4	4	ECO	Mode alternative pin. ( $V_{ECO} = V_{in}$ for FT mode; $V_{ECO} = GND$ for LP mode)
5	2	GND	Power supply ground.
6	3	$\overline{CE}$ or CE	Chip enable pin.

## MAXIMUM RATINGS

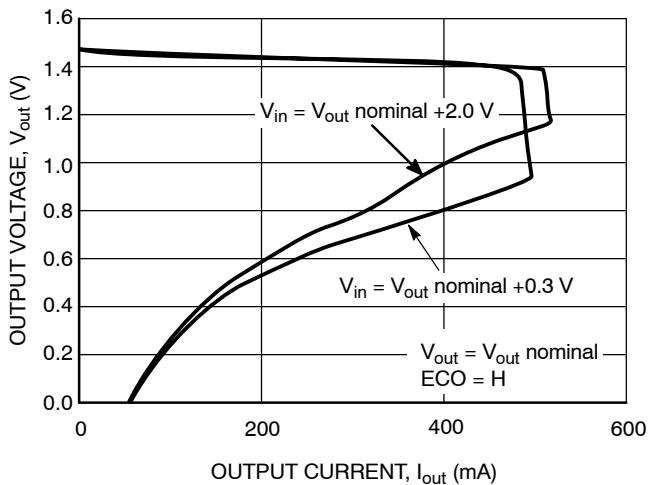
Rating	Symbol	Value	Unit
Input Voltage	V <sub>in</sub>	6.5	V
Input Voltage ( $\bar{C}E$ or CE Pin)	V <sub>CE</sub>	-0.3 to 6.5	V
Input Voltage (ECO Pin)	V <sub>ECO</sub>	-0.3 to 6.5	V
Output Voltage	V <sub>out</sub>	-0.3 to V <sub>in</sub> + 0.3	V
Output Current	I <sub>out</sub>	350	mA
Power Dissipation SOT23-5 HSON-6	P <sub>D</sub>	250 400	mW
ESD Capability, Human Body Model, C = 100 pF, R = 1.5 kΩ	ESD <sub>HBM</sub>	2000	V
ESD Capability, Machine Model, C = 200 pF, R = 0 Ω	ESD <sub>MM</sub>	150	V
Operating Ambient Temperature Range	T <sub>A</sub>	-40 to +85	°C
Maximum Junction Temperature	T <sub>J(max)</sub>	125	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

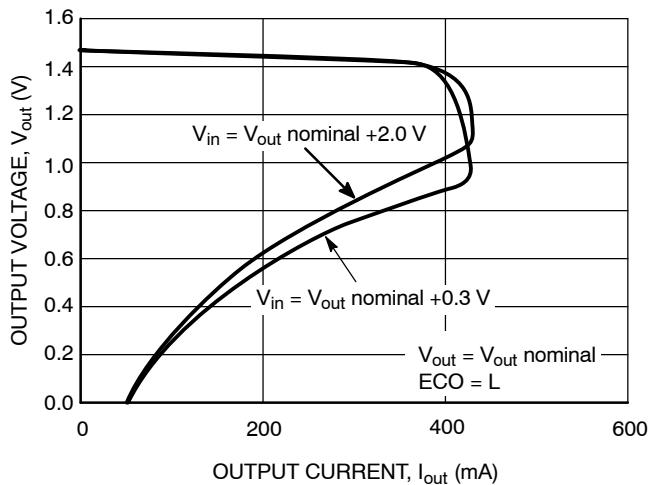
ELECTRICAL CHARACTERISTICS (V<sub>in</sub> = V<sub>out</sub> + 1.0 V, T<sub>A</sub> = 25°C, unless otherwise noted.)

Characteristic	Symbol	Min	Typ		Max	Unit
Input Voltage	V <sub>in</sub>	1.4	–		6.0	V
Output Voltage (1.0 μA ≤ I <sub>out</sub> ≤ 30 mA) V <sub>ECO</sub> = V <sub>in</sub> V <sub>ECO</sub> = GND	V <sub>out</sub>	V <sub>out</sub> × 0.980 V <sub>out</sub> × 0.970	– –		V <sub>out</sub> × 1.020 V <sub>out</sub> × 1.030	V
Line Regulation (I <sub>out</sub> = 30 mA, V <sub>out</sub> + 0.5 V ≤ V <sub>in</sub> ≤ 6.0 V) FT Mode V <sub>ECO</sub> = V <sub>in</sub> LP Mode V <sub>ECO</sub> = GND	Reg <sub>line</sub>	– –	0.01 0.05		0.15 0.20	%/V
Load Regulation FT Mode (1.0 mA ≤ I <sub>out</sub> ≤ 300 mA), V <sub>ECO</sub> = V <sub>in</sub> LP Mode (1.0 mA ≤ I <sub>out</sub> ≤ 100 mA), V <sub>ECO</sub> = GND	Reg <sub>load</sub>	– –	40 15		70 30	mV
Dropout Voltage (I <sub>out</sub> = 300 mA) V <sub>out</sub> = 0.9 V 1.0 V ≤ V <sub>out</sub> ≤ 1.25 V 1.5 V ≤ V <sub>out</sub> ≤ 2.5 V 2.8 V ≤ V <sub>out</sub> ≤ 3.3 V	V <sub>DO</sub>	– – – –	ECO = H 0.55 0.48 0.31 0.23	ECO = L 0.59 0.51 0.32 0.24	ECO = H 0.78 0.70 0.45 0.35	V 0.80 0.75 0.48 0.375
Quiescent Current (I <sub>out</sub> = 0 mA) FT Mode, V <sub>ECO</sub> = V <sub>in</sub> V <sub>out</sub> < 1.8 V V <sub>out</sub> ≥ 1.8 V LP Mode, V <sub>ECO</sub> = GND V <sub>out</sub> < 1.6 V V <sub>out</sub> ≥ 1.8 V	I <sub>Q</sub>	– – – –	80 60		111 90	μA
Output Current (V <sub>in</sub> – V <sub>out</sub> = 1.0 V)	I <sub>out</sub>	300	–		–	mA
Shutdown Current (V <sub>CE</sub> = V <sub>in</sub> )	I <sub>SD</sub>	–	0.1		1.0	μA
Output Short Circuit Current (V <sub>out</sub> = 0 V)	I <sub>lim</sub>	–	50		–	mA
Enable Input Threshold Voltage – High – Low	V <sub>th<sub>enh</sub></sub> V <sub>th<sub>enl</sub></sub>	1.0 0.0	–		V <sub>in</sub> 0.3	V
Output Noise Voltage (10 Hz – 100 kHz)	V <sub>n</sub>	–	30		–	μVrms
N-Channel On Resistance for Auto Discharge	R <sub>Low</sub>	–	60		–	Ω
Ripple Rejection (I <sub>out</sub> = 50 mA, V <sub>out</sub> = 0.9 V, V <sub>in</sub> – V <sub>out</sub> = 1.0 V) f = 120 Hz f = 1.0 kHz f = 10 kHz	RR	– – –	75 70 65		– – –	dB
Output Voltage Temperature Coefficient (I <sub>out</sub> = 30 mA, -40°C ≤ T <sub>A</sub> ≤ 85°C)	ΔV <sub>out</sub> / ΔT	–	±100		–	ppm/ °C

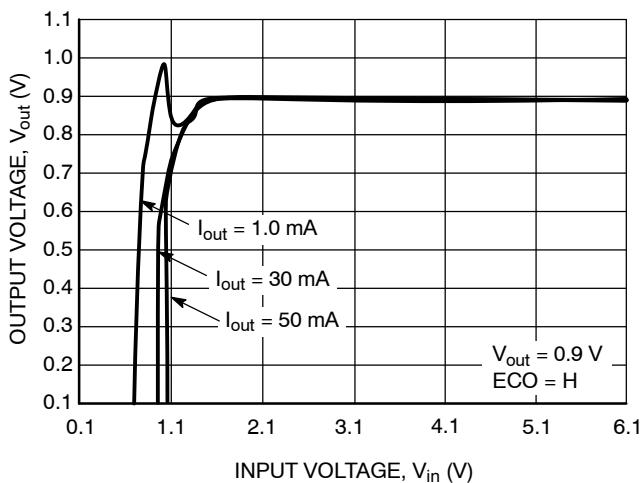
**TYPICAL CHARACTERISTICS**



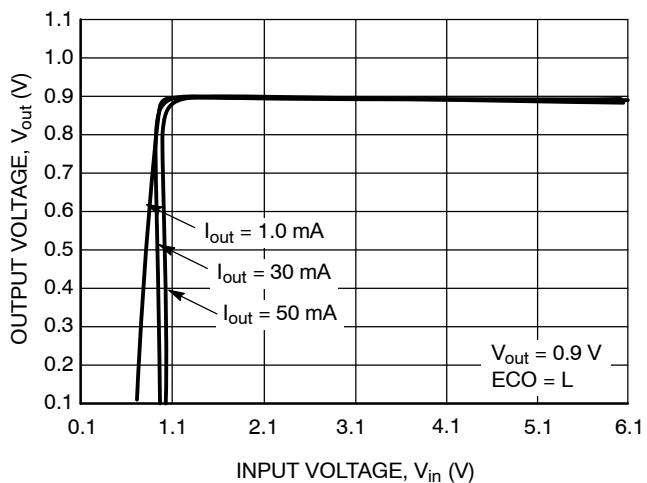
**Figure 4. Output Voltage vs. Output Current**



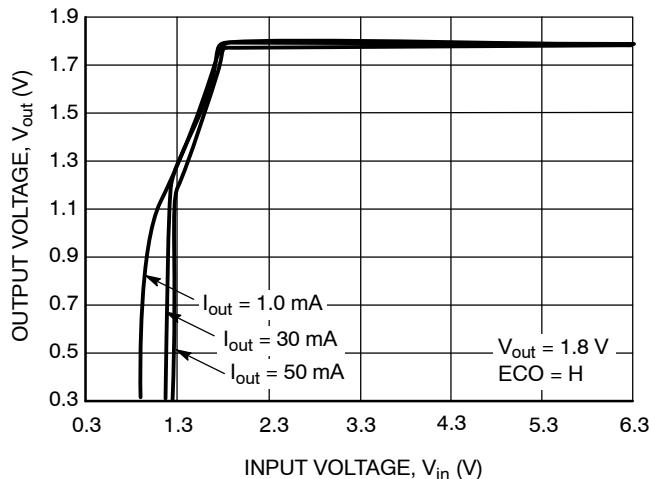
**Figure 5. Output Voltage vs. Output Current**



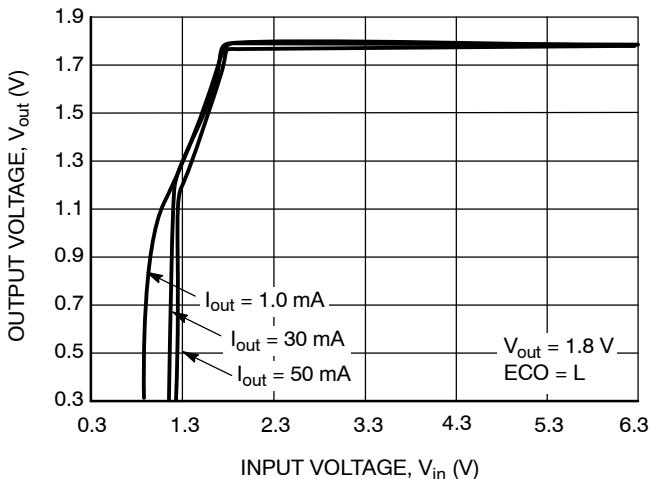
**Figure 6. Output Voltage vs. Input Voltage**



**Figure 7. Output Voltage vs. Input Voltage**

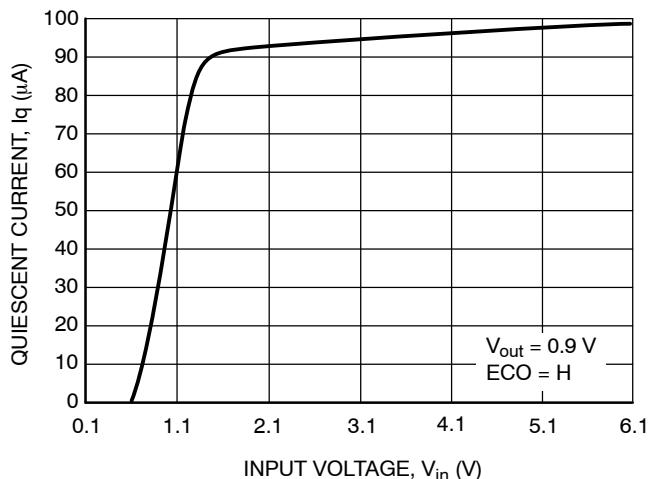


**Figure 8. Output Voltage vs. Input Voltage**

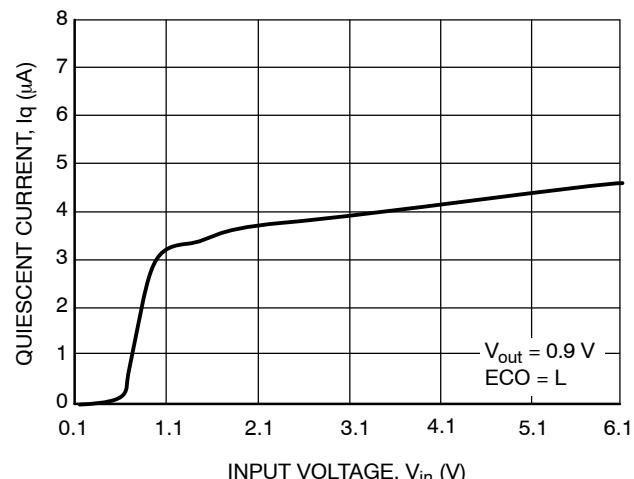


**Figure 9. Output Voltage vs. Input Voltage**

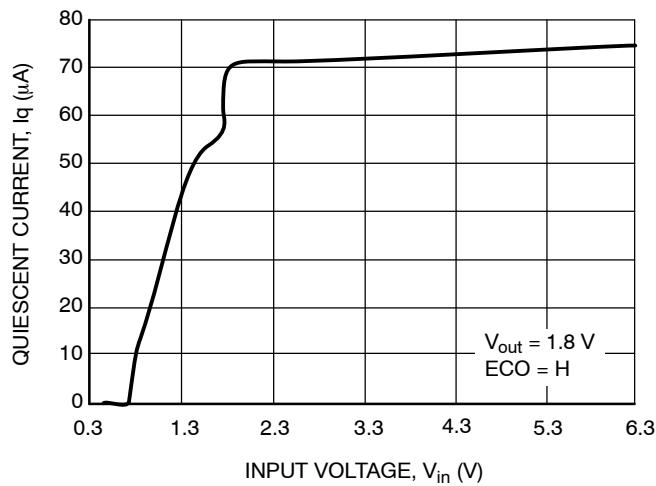
**TYPICAL CHARACTERISTICS**



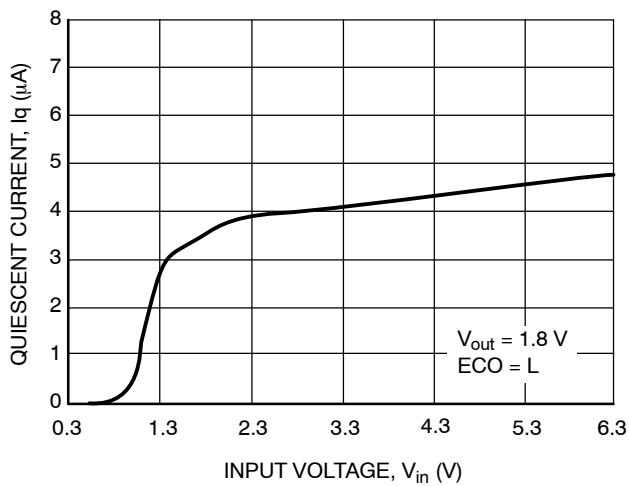
**Figure 10. Quiescent Current vs. Input Voltage**



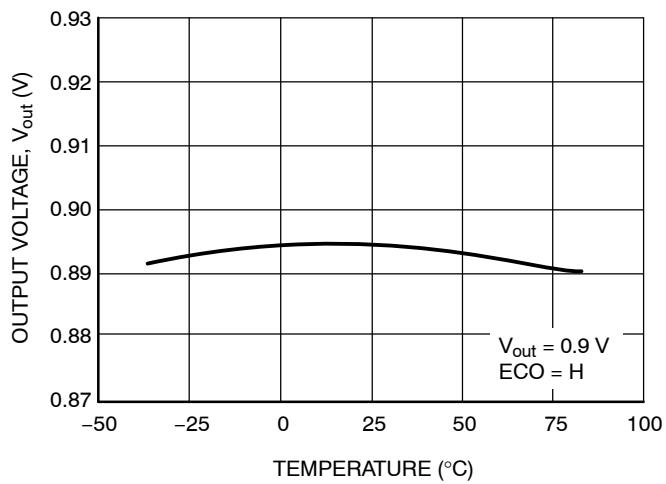
**Figure 11. Quiescent Current vs. Input Voltage**



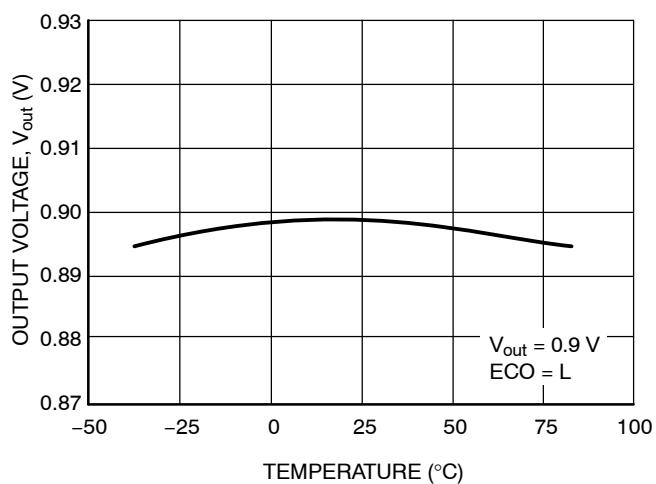
**Figure 12. Quiescent Current vs. Input Voltage**



**Figure 13. Quiescent Current vs. Input Voltage**

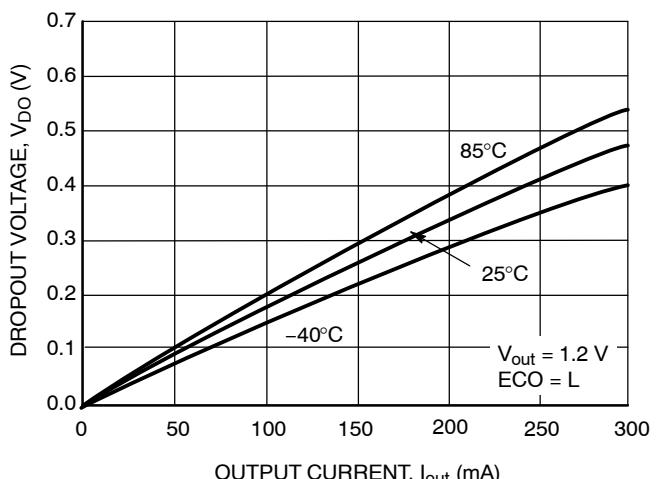
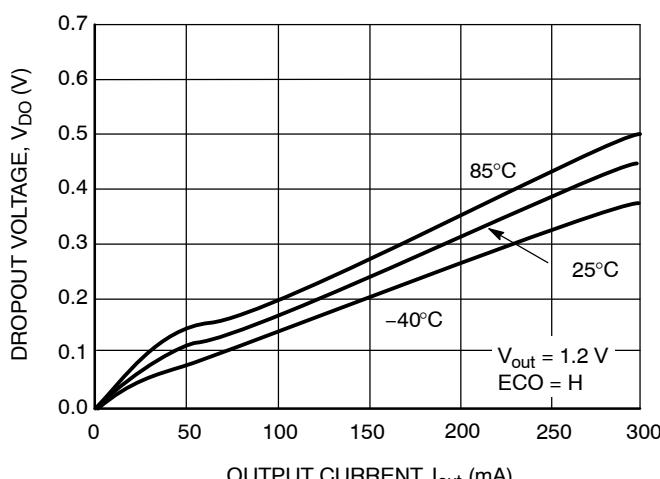
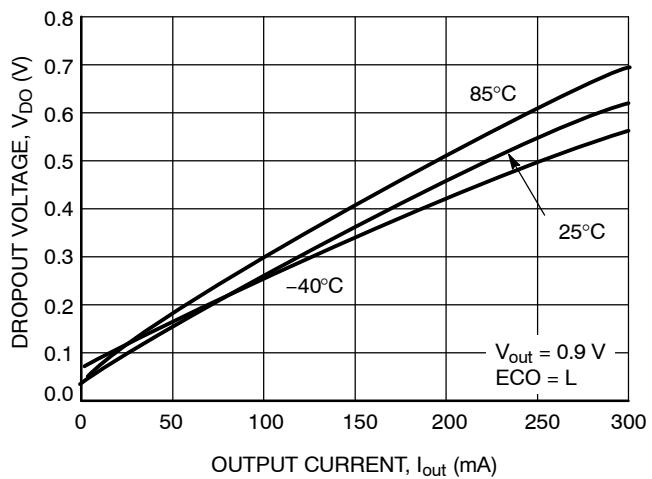
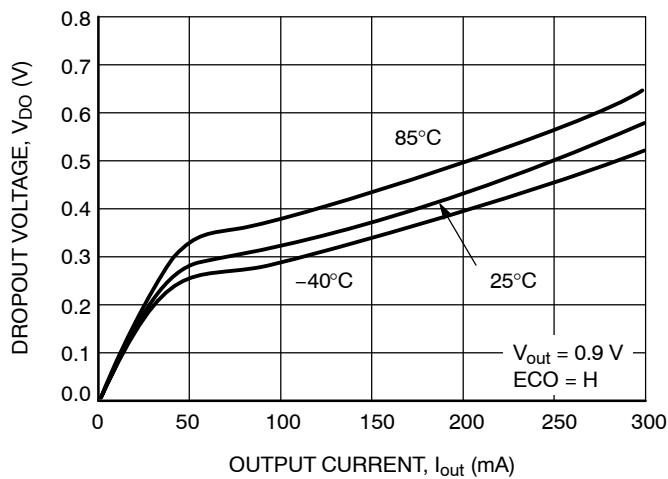
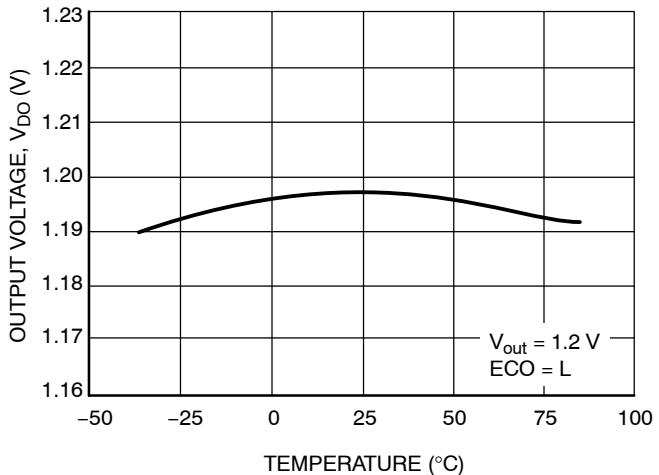
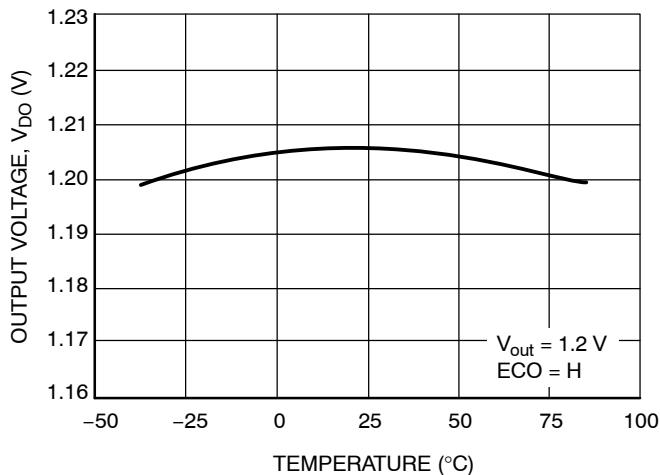


**Figure 14. Output Voltage vs. Temperature**



**Figure 15. Output Voltage vs. Temperature**

## TYPICAL CHARACTERISTICS



## TYPICAL CHARACTERISTICS

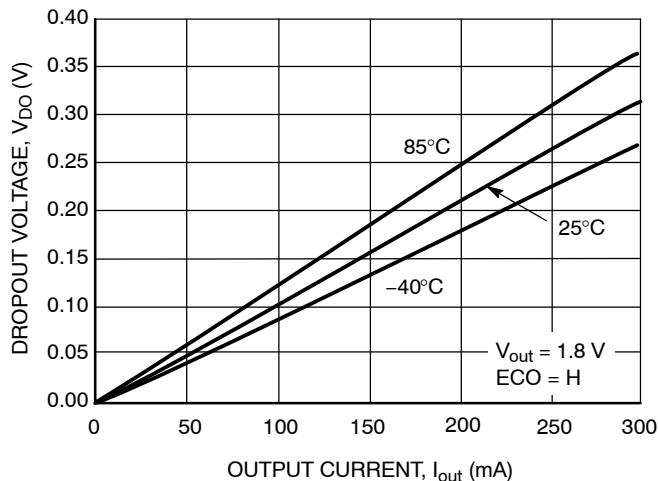


Figure 22. Dropout Voltage vs. Output Current

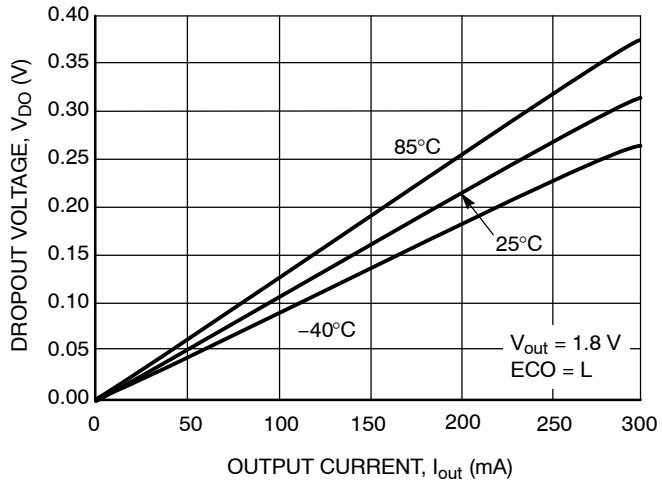


Figure 23. Dropout Voltage vs. Output Current

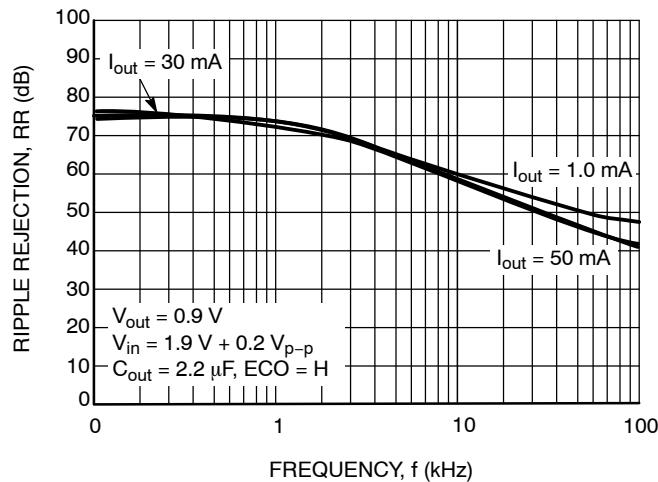


Figure 24. Ripple Rejection vs. Frequency

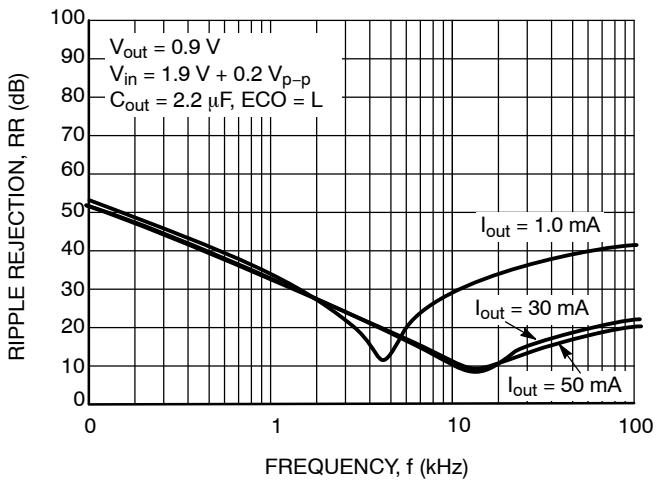


Figure 25. Ripple Rejection vs. Frequency

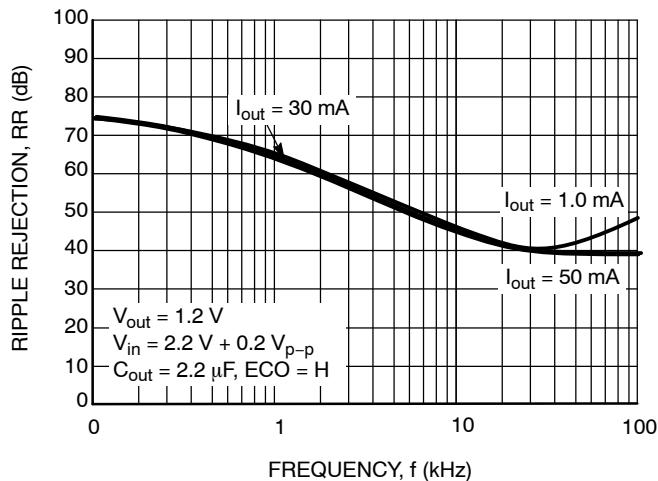


Figure 26. Ripple Rejection vs. Frequency

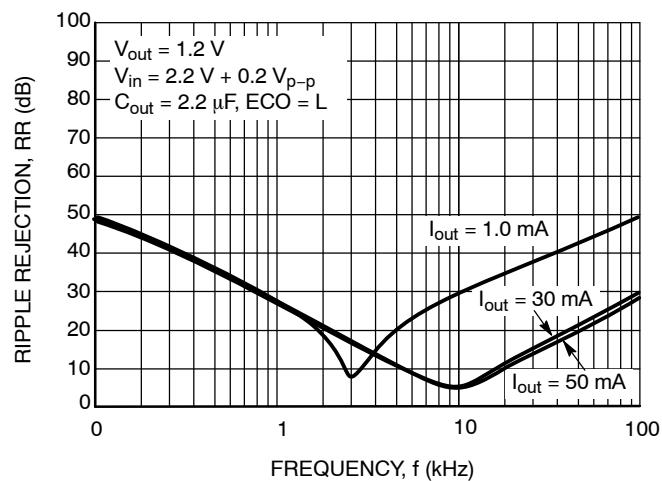


Figure 27. Ripple Rejection vs. Frequency

# NCP585

## TYPICAL CHARACTERISTICS

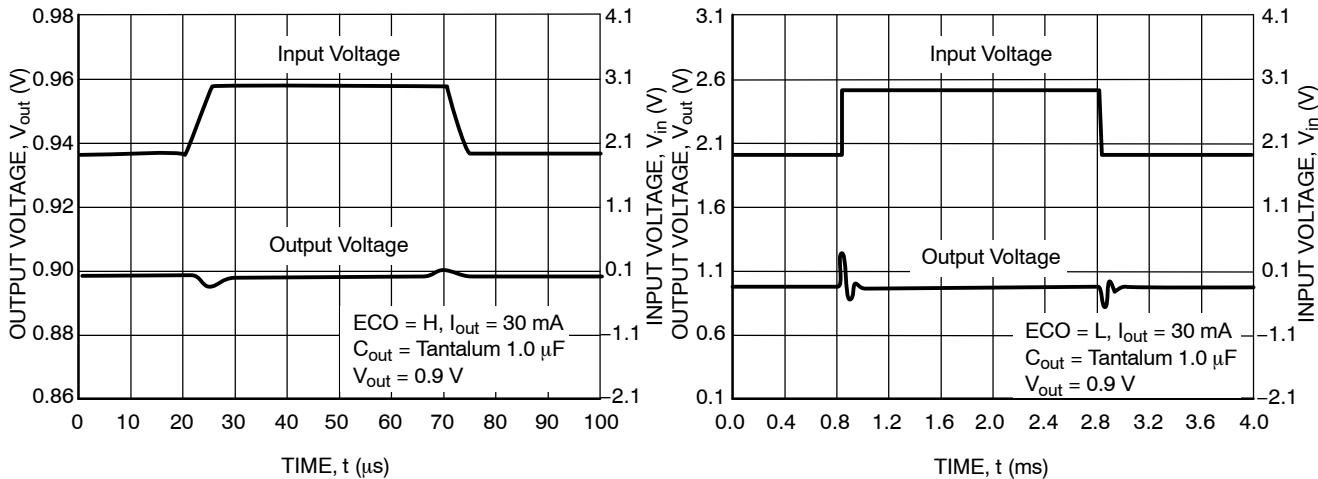


Figure 28. Input Transient Response

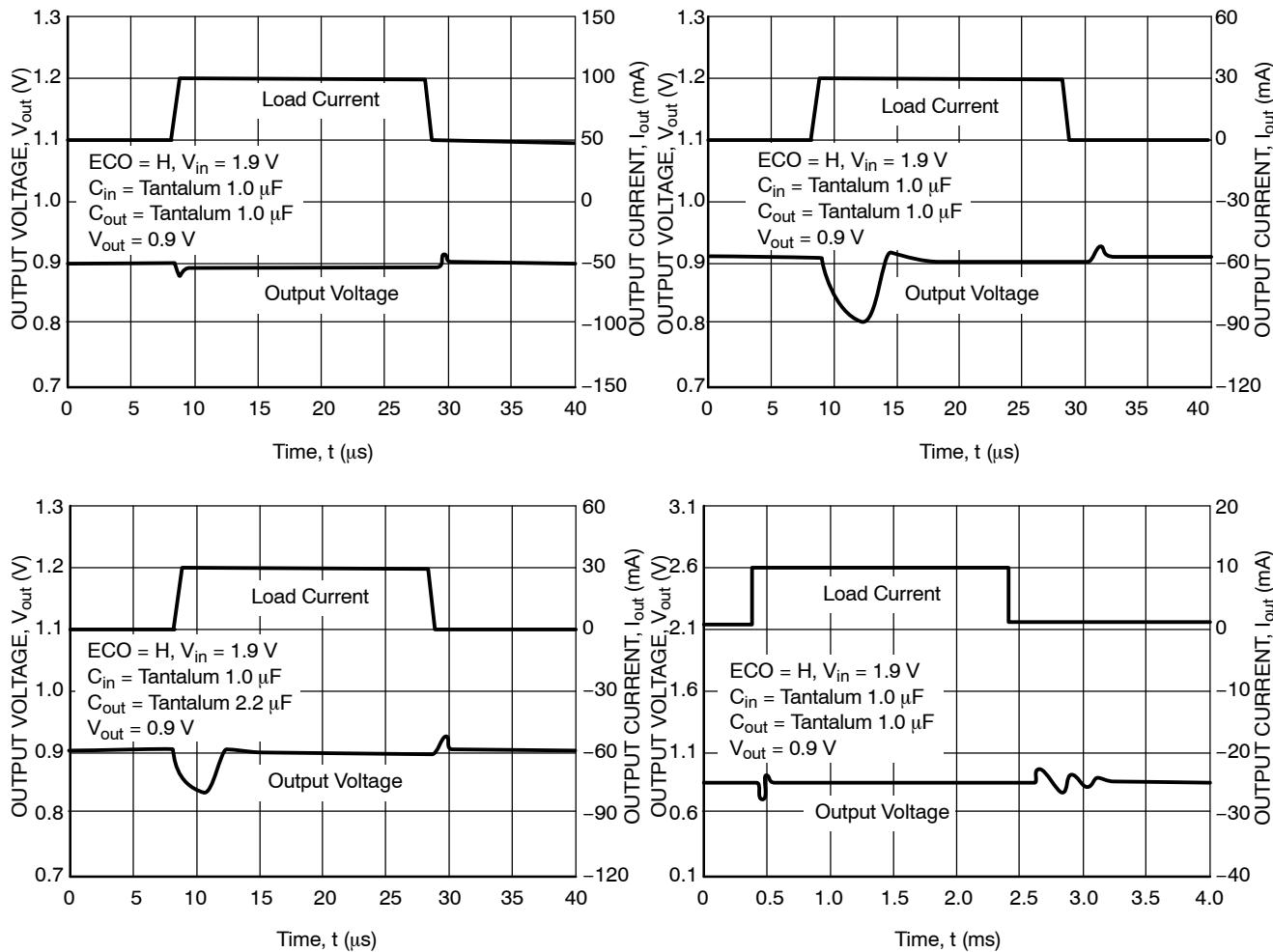


Figure 29. Load Transient Response

# NCP585

## TYPICAL CHARACTERISTICS

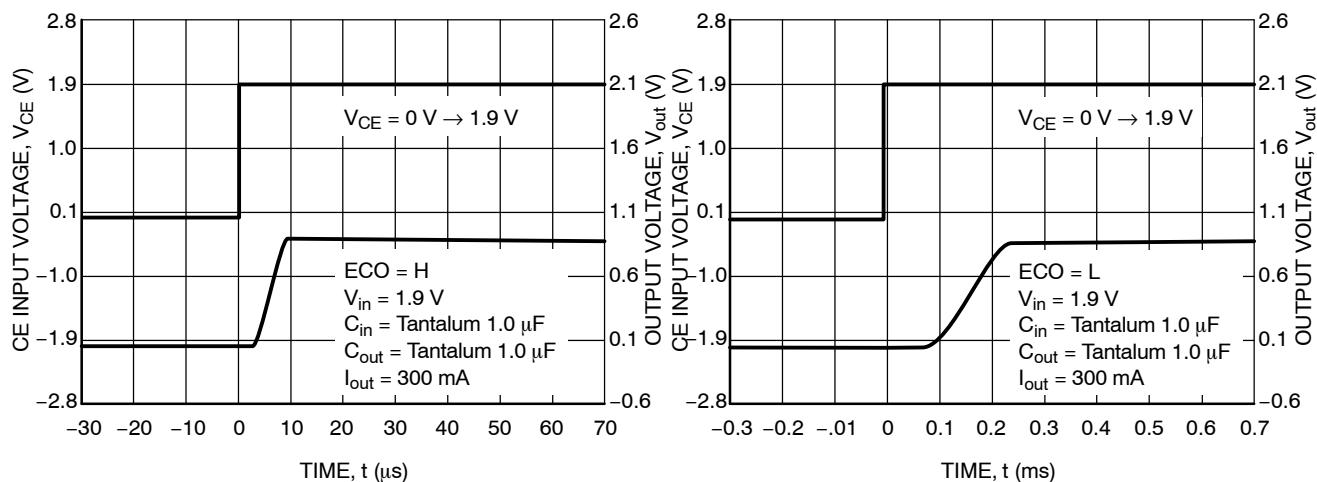


Figure 30. Turn-On Speed with CE Pin,  $V_{out} = 0.8 \text{ V}$

$V_{in} = 1.9 \text{ V}$ ,  $C_{in} = \text{Tantalum } 1.0 \mu\text{F}$ ,  $C_{out} = \text{Tantalum } 1.0 \mu\text{F}$ ,  $V_{out} = 0.9 \text{ V}$

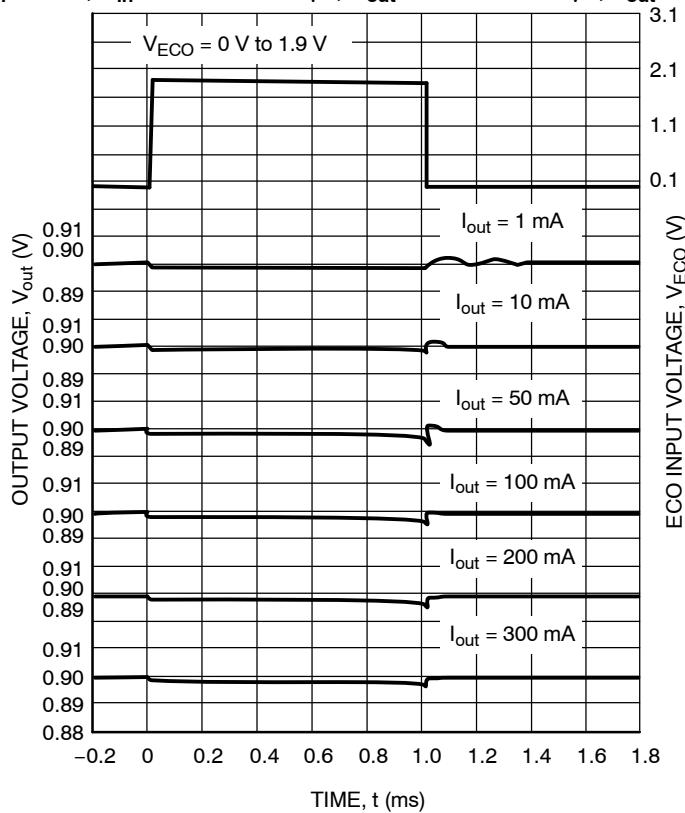
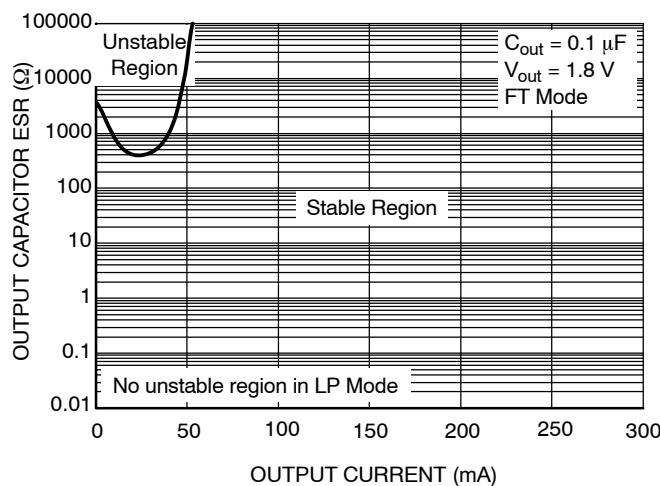
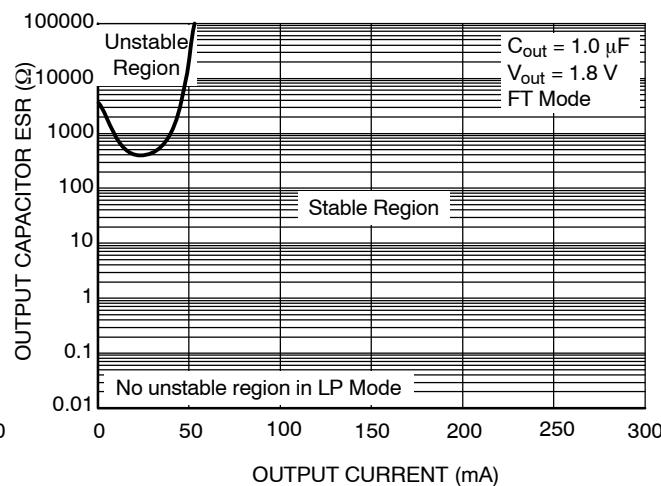


Figure 31. Output Voltage at Mode Alternative Point

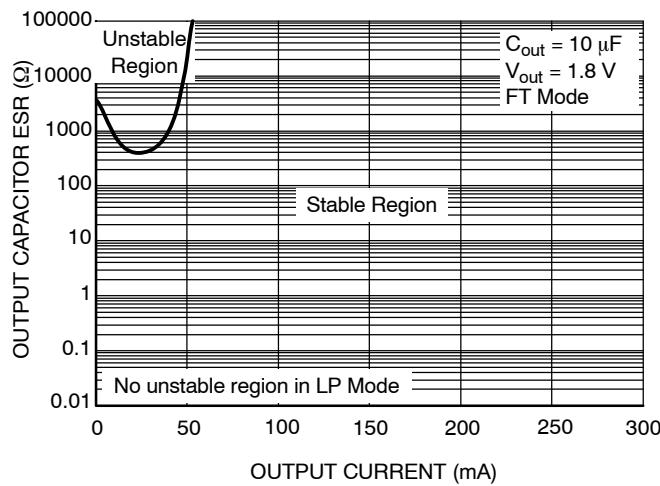
## TYPICAL CHARACTERISTICS



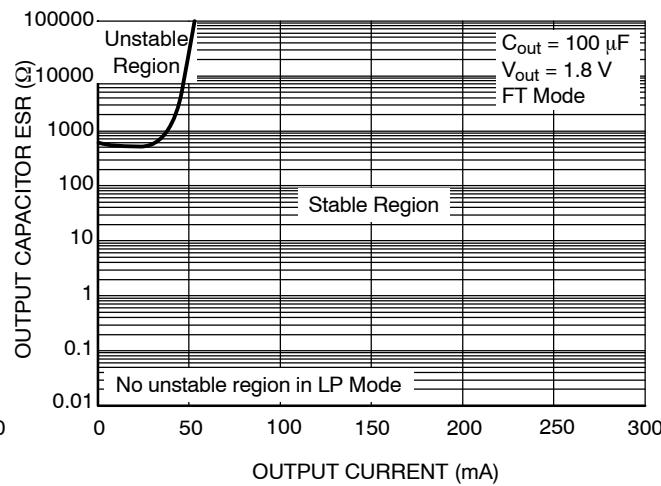
**Figure 32. Output Stability, Output Capacitor ESR vs. Output Load Current ( $0.1 \mu F$ )**



**Figure 33. Output Stability, Output Capacitor ESR vs. Output Load Current ( $1.0 \mu F$ )**



**Figure 34. Output Stability, Output Capacitor ESR vs. Output Load Current ( $10 \mu F$ )**



**Figure 35. Output Stability, Output Capacitor ESR vs. Output Load Current ( $100 \mu F$ )**

## APPLICATION INFORMATION

**Input Decoupling**

A  $1.0 \mu F$  ceramic capacitor is the recommended value to be connected between  $V_{in}$  and GND. For PCB layout considerations, the traces on  $V_{in}$  and GND should be sufficiently wide in order to minimize noise and prevent unstable operation.

**Output Decoupling**

It is best to use a  $1.0 \mu F$  capacitor value on the  $V_{out}$  pin. For better performance, select a capacitor with low Equivalent Series Resistance (ESR). For PCB layout considerations, place the output capacitor close to the output pin and keep the leads short as possible.

# NCP585

## ORDERING INFORMATION

Device	Output Type / Features	Nominal Output Voltage	Marking	Package	Shipping <sup>†</sup>
NCP585DSAN09T1G	Active High w/Auto Discharge, LP and FT Mode	0.9	B09D	HSON-6 (Pb-Free)	3000 Tape & Reel
NCP585DSAN12T1G	Active High w/Auto Discharge, LP and FT Mode	1.2	B12D	HSON-6 (Pb-Free)	3000 Tape & Reel
NCP585DSAN18T1G	Active High w/Auto Discharge, LP and FT Mode	1.8	B18D	HSON-6 (Pb-Free)	3000 Tape & Reel
NCP585DSN09T1G	Active High w/Auto Discharge, LP and FT Mode	0.9	R09	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN12T1G	Active High w/Auto Discharge, LP and FT Mode	1.2	R12	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN125T1G	Active High w/Auto Discharge, LP and FT Mode	1.25	R01	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN15T1G	Active High w/Auto Discharge, LP and FT Mode	1.5	R15	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN18T1G	Active High w/Auto Discharge, LP and FT Mode	1.8	R18	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN25T1G	Active High w/Auto Discharge, LP and FT Mode	2.5	R25	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN28T1G	Active High w/Auto Discharge, LP and FT Mode	2.8	R28	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN30T1G	Active High w/Auto Discharge, LP and FT Mode	3.0	R30	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN33T1G	Active High w/Auto Discharge, LP and FT Mode	3.3	R33	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585HSAN09T1G	Active High, LP and FT Mode	0.9	B09B	HSON-6 (Pb-Free)	3000 Tape & Reel
NCP585HSAN12T1G	Active High, LP and FT Mode	1.2	B12B	HSON-6 (Pb-Free)	3000 Tape & Reel
NCP585HSAN18T1G	Active High, LP and FT Mode	1.8	B18B	HSON-6 (Pb-Free)	3000 Tape & Reel
NCP585HSN09T1G	Active High, LP and FT Mode	0.9	Q09	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585HSN10T1G	Active High, LP and FT Mode	1.0	Q10	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585HSN12T1G	Active High, LP and FT Mode	1.2	Q12	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585HSN18T1G	Active High, LP and FT Mode	1.8	Q18	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585HSN30T1G	Active High, LP and FT Mode	3.0	Q30	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585LSAN09T1G	Active Low, LP and FT Mode	0.9	B09A	HSON-6 (Pb-Free)	3000 Tape & Reel
NCP585LSAN12T1G	Active Low, LP and FT Mode	1.2	B12A	HSON-6 (Pb-Free)	3000 Tape & Reel
NCP585LSAN18T1G	Active Low, LP and FT Mode	1.8	B18A	HSON-6 (Pb-Free)	3000 Tape & Reel
NCP585LSN09T1G	Active Low, LP and FT Mode	0.9	P09	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585LSN12T1G	Active Low, LP and FT Mode	1.2	P12	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585LSN18T1G	Active Low, LP and FT Mode	1.8	P18	SOT23-5 (Pb-Free)	3000 Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Other voltages are available. Consult your ON Semiconductor representative.

# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

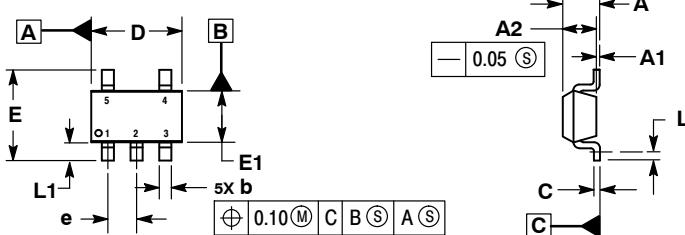
ON Semiconductor®



SCALE 2:1

### SOT-23 5-LEAD CASE 1212-01 ISSUE A

DATE 28 JAN 2011

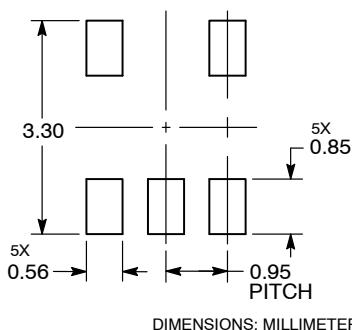


#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSIONS: MILLIMETERS.
3. DATUM C IS THE SEATING PLANE.

	MILLIMETERS	
DIM	MIN	MAX
A	---	1.45
A1	0.00	0.10
A2	1.00	1.30
b	0.30	0.50
c	0.10	0.25
D	2.70	3.10
E	2.50	3.10
E1	1.50	1.80
e	0.95 BSC	---
L	0.20	---
L1	0.45	0.75

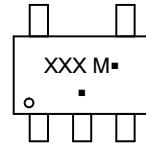
### RECOMMENDED SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### GENERIC MARKING DIAGRAM\*



XXX = Specific Device Code

M = Date Code

▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

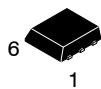
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DESCRIPTION:	SOT-23 5-LEAD	PAGE 1 OF 1

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# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

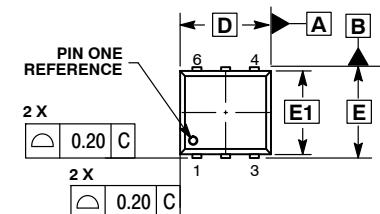
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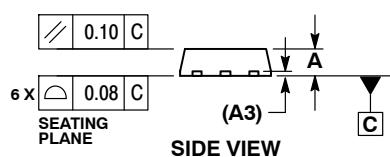
SCALE 2:1

**HSON-6**  
CASE 506AE-01  
ISSUE A

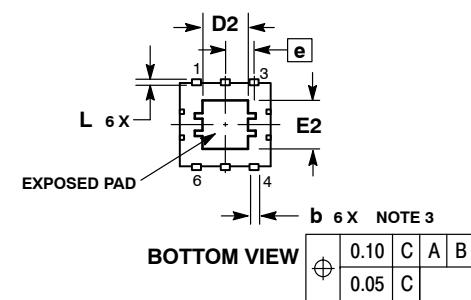
DATE 26 JAN 2005



TOP VIEW



SIDE VIEW



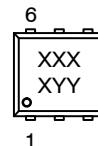
BOTTOM VIEW

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.10 AND 0.15 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.70	0.90
A3	0.15 REF	
b	0.20	0.40
D	2.90 BSC	
D2	1.40	1.60
E	3.00 BSC	
E1	2.80 BSC	
E2	1.50	1.70
e	0.95 BSC	
L	0.15	0.25

GENERIC  
MARKING DIAGRAM\*



XXXX = Specific Device Code  
YY = Wafer Lot

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present.

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DESCRIPTION:	HSON-6, 2.9 X 3.0 MM, 0.95 MM PITCH	PAGE 1 OF 1

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